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Details

Product Status	Discontinued at Digi-Key
Core Processor	XC800
Core Size	8-Bit
Speed	24MHz
Connectivity	SSI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	48
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1.75K x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	PG-TQFP-64
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/xc888ffi5vacfxuma1

8-Bit

XC886/888CLM

8-Bit Single Chip Microcontroller

Data Sheet

V1.2 2009-07

Microcontrollers

General Device Information
2.4 Pin Definitions and Functions

The functions and default states of the XC886/888 external pins are provided in [Table 3](#).

Table 3 Pin Definitions and Functions

Symbol	Pin Number (TQFP-48/64)	Type	Reset State	Function
P0		I/O		Port 0 Port 0 is an 8-bit bidirectional general purpose I/O port. It can be used as alternate functions for the JTAG, CCU6, UART, UART1, Timer 2, Timer 21, MultiCAN and SSC.
P0.0	11/17		Hi-Z	<div>TCK_0 JTAG Clock Input</div> <div>T12HR_1 CCU6 Timer 12 Hardware Run Input</div> <div>CC61_1 Input/Output of Capture/Compare channel 1</div> <div>CLKOUT_0 Clock Output</div> <div>RXDO_1 UART Transmit Data Output</div>
P0.1	13/21		Hi-Z	<div>TDI_0 JTAG Serial Data Input</div> <div>T13HR_1 CCU6 Timer 13 Hardware Run Input</div> <div>RXD_1 UART Receive Data Input</div> <div>RXDC1_0 MultiCAN Node 1 Receiver Input</div> <div>COUT61_1 Output of Capture/Compare channel 1</div> <div>EXF2_1 Timer 2 External Flag Output</div>
P0.2	12/18		PU	<div>CTRAP_2 CCU6 Trap Input</div> <div>TDO_0 JTAG Serial Data Output</div> <div>TXD_1 UART Transmit Data Output/Clock Output</div> <div>TXDC1_0 MultiCAN Node 1 Transmitter Output</div>
P0.3	48/63		Hi-Z	<div>SCK_1 SSC Clock Input/Output</div> <div>COUT63_1 Output of Capture/Compare channel 3</div> <div>RXDO1_0 UART1 Transmit Data Output</div>

Functional Description
Table 5 CPU Register Overview (cont'd)

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
A8 _H	IEN0 Reset: 00_H Interrupt Enable Register 0	Bit Field	EA	0	ET2	ES	ET1	EX1	ET0	EX0
		Type	rw	r	rw	rw	rw	rw	rw	rw
B8 _H	IP Reset: 00_H Interrupt Priority Register	Bit Field	0		PT2	PS	PT1	PX1	PT0	PX0
		Type	r		rw	rw	rw	rw	rw	rw
B9 _H	IPH Reset: 00_H Interrupt Priority High Register	Bit Field	0		PT2H	PSH	PT1H	PX1H	PT0H	PX0H
		Type	r		rw	rw	rw	rw	rw	rw
D0 _H	PSW Reset: 00_H Program Status Word Register	Bit Field	CY	AC	F0	RS1	RS0	OV	F1	P
		Type	rwh	rwh	rw	rw	rw	rwh	rw	rh
E0 _H	ACC Reset: 00_H Accumulator Register	Bit Field	ACC7	ACC6	ACC5	ACC4	ACC3	ACC2	ACC1	ACC0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
E8 _H	IEN1 Reset: 00_H Interrupt Enable Register 1	Bit Field	ECCIP 3	ECCIP 2	ECCIP 1	ECCIP 0	EXM	EX2	ESSC	EADC
		Type	rw	rw	rw	rw	rw	rw	rw	rw
F0 _H	B Reset: 00_H B Register	Bit Field	B7	B6	B5	B4	B3	B2	B1	B0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
F8 _H	IP1 Reset: 00_H Interrupt Priority 1 Register	Bit Field	PCCIP 3	PCCIP 2	PCCIP 1	PCCIP 0	PXM	PX2	PSSC	PADC
		Type	rw	rw	rw	rw	rw	rw	rw	rw
F9 _H	IPH1 Reset: 00_H Interrupt Priority 1 High Register	Bit Field	PCCIP 3H	PCCIP 2H	PCCIP 1H	PCCIP 0H	PXMH	PX2H	PSSC H	PADC H
		Type	rw	rw	rw	rw	rw	rw	rw	rw

3.2.4.2 MDU Registers

The MDU SFRs can be accessed in the mapped memory area (RMAP = 1).

Table 6 MDU Register Overview

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
RMAP = 1										
B0 _H	MDUSTAT Reset: 00_H MDU Status Register	Bit Field	0					BSY	IERR	IRDY
		Type	r					rh	rwh	rwh
B1 _H	MDUCON Reset: 00_H MDU Control Register	Bit Field	IE	IR	RSEL	STAR T	OPCODE			
		Type	rw	rw	rw	rwh	rw			
B2 _H	MD0 Reset: 00_H MDU Operand Register 0	Bit Field	DATA							
		Type	rw							
B2 _H	MR0 Reset: 00_H MDU Result Register 0	Bit Field	DATA							
		Type	rh							
B3 _H	MD1 Reset: 00_H MDU Operand Register 1	Bit Field	DATA							
		Type	rw							

Functional Description

Table 7 CORDIC Register Overview (cont'd)

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
A0 _H	CD_STATC Reset: 00 _H CORDIC Status and Data Control Register	Bit Field	KEEP Z	KEEP Y	KEEP X	DMAP	INT_EN	EOC	ERROR	BSY
		Type	rw	rw	rw	rw	rw	rwh	rh	rh
A1 _H	CD_CON Reset: 00 _H CORDIC Control Register	Bit Field	MPS		X_USIGN	ST_MODE	ROTV EC	MODE		ST
		Type	rw		rw	rw	rw	rw		rwh

3.2.4.4 System Control Registers

The system control SFRs can be accessed in the mapped memory area (RMAP = 0).

Table 8 SCU Register Overview

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
RMAP = 0 or 1										
8F _H	SYSCON0 Reset: 04_H System Control Register 0	Bit Field	0			IMOD E	0	1	0	RMAP
		Type	r			rw	r	r	r	rw
RMAP = 0										
BF _H	SCU_PAGE Reset: 00_H Page Register	Bit Field	OP		STNR		0	PAGE		
		Type	w		w		r	rw		
RMAP = 0, PAGE 0										
B3 _H	MODPISEL Reset: 00_H Peripheral Input Select Register	Bit Field	0	URRIS H	JTAGT DIS	JTAGT CKS	EXINT 2IS	EXINT 1IS	EXINT 0IS	URRIS
		Type	r	rw	rw	rw	rw	rw	rw	rw
B4 _H	IRCON0 Reset: 00_H Interrupt Request Register 0	Bit Field	0	EXINT 6	EXINT 5	EXINT 4	EXINT 3	EXINT 2	EXINT 1	EXINT 0
		Type	r	rwh	rwh	rwh	rwh	rwh	rwh	rwh
B5 _H	IRCON1 Reset: 00_H Interrupt Request Register 1	Bit Field	0	CANS RC2	CANS RC1	ADCS R1	ADCS R0	RIR	TIR	EIR
		Type	r	rwh	rwh	rwh	rwh	rwh	rwh	rwh
B6 _H	IRCON2 Reset: 00_H Interrupt Request Register 2	Bit Field	0			CANS RC3	0			CANS RC0
		Type	r			rwh	r			rwh
B7 _H	EXICON0 Reset: F0_H External Interrupt Control Register 0	Bit Field	EXINT3		EXINT2		EXINT1		EXINT0	
		Type	rw		rw		rw		rw	
BA _H	EXICON1 Reset: 3F_H External Interrupt Control Register 1	Bit Field	0		EXINT6		EXINT5		EXINT4	
		Type	r		rw		rw		rw	
BB _H	NMICON Reset: 00_H NMI Control Register	Bit Field	0	NMI ECC	NMI VDDP	NMI VDD	NMI OCDS	NMI FLASH	NMI PLL	NMI WDT
		Type	r	rw	rw	rw	rw	rw	rw	rw

Functional Description

Table 11 ADC Register Overview (cont'd)

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
D3 _H	ADC_RESR3H Reset: 00 _H Result Register 3 High	Bit Field	RESULT							
		Type	rh							
RMAP = 0, PAGE 3										
CA _H	ADC_RESRA0L Reset: 00 _H Result Register 0, View A Low	Bit Field	RESULT			VF	DRC	CHNR		
		Type	rh			rh	rh	rh		
CB _H	ADC_RESRA0H Reset: 00 _H Result Register 0, View A High	Bit Field	RESULT							
		Type	rh							
CC _H	ADC_RESRA1L Reset: 00 _H Result Register 1, View A Low	Bit Field	RESULT			VF	DRC	CHNR		
		Type	rh			rh	rh	rh		
CD _H	ADC_RESRA1H Reset: 00 _H Result Register 1, View A High	Bit Field	RESULT							
		Type	rh							
CE _H	ADC_RESRA2L Reset: 00 _H Result Register 2, View A Low	Bit Field	RESULT			VF	DRC	CHNR		
		Type	rh			rh	rh	rh		
CF _H	ADC_RESRA2H Reset: 00 _H Result Register 2, View A High	Bit Field	RESULT							
		Type	rh							
D2 _H	ADC_RESRA3L Reset: 00 _H Result Register 3, View A Low	Bit Field	RESULT			VF	DRC	CHNR		
		Type	rh			rh	rh	rh		
D3 _H	ADC_RESRA3H Reset: 00 _H Result Register 3, View A High	Bit Field	RESULT							
		Type	rh							
RMAP = 0, PAGE 4										
CA _H	ADC_RCR0 Reset: 00 _H Result Control Register 0	Bit Field	VFCT R	WFR	0	IEN	0			DRCT R
		Type	rw	rw	r	rw	r			rw
CB _H	ADC_RCR1 Reset: 00 _H Result Control Register 1	Bit Field	VFCT R	WFR	0	IEN	0			DRCT R
		Type	rw	rw	r	rw	r			rw
CC _H	ADC_RCR2 Reset: 00 _H Result Control Register 2	Bit Field	VFCT R	WFR	0	IEN	0			DRCT R
		Type	rw	rw	r	rw	r			rw
CD _H	ADC_RCR3 Reset: 00 _H Result Control Register 3	Bit Field	VFCT R	WFR	0	IEN	0			DRCT R
		Type	rw	rw	r	rw	r			rw
CE _H	ADC_VFCR Reset: 00 _H Valid Flag Clear Register	Bit Field	0				VFC3	VFC2	VFC1	VFC0
		Type	r				w	w	w	w
RMAP = 0, PAGE 5										
CA _H	ADC_CHINFR Reset: 00 _H Channel Interrupt Flag Register	Bit Field	CHINF 7	CHINF 6	CHINF 5	CHINF 4	CHINF 3	CHINF 2	CHINF 1	CHINF 0
		Type	rh	rh	rh	rh	rh	rh	rh	rh
CB _H	ADC_CHINCR Reset: 00 _H Channel Interrupt Clear Register	Bit Field	CHINC 7	CHINC 6	CHINC 5	CHINC 4	CHINC 3	CHINC 2	CHINC 1	CHINC 0
		Type	w	w	w	w	w	w	w	w

Functional Description
Table 14 CCU6 Register Overview (cont'd)

Addr	Register Name	Bit	7	6	5	4	3	2	1	0	
FB _H	CCU6_TCTR2H Reset: 00_H Timer Control Register 2 High	Bit Field	0				T13RSEL		T12RSEL		
		Type	r				rw		rw		
FC _H	CCU6_MODCTRL Reset: 00_H Modulation Control Register Low	Bit Field	MCM EN	0	T12MODEN						
		Type	rw	r	rw						
FD _H	CCU6_MODCTRH Reset: 00_H Modulation Control Register High	Bit Field	ECT1 3O	0	T13MODEN						
		Type	rw	r	rw						
FE _H	CCU6_TRPCTRL Reset: 00_H Trap Control Register Low	Bit Field	0					TRPM 2	TRPM 1	TRPM 0	
		Type	r					rw	rw	rw	
FF _H	CCU6_TRPCTRH Reset: 00_H Trap Control Register High	Bit Field	TRPP EN	TRPE N13	TRPEN						
		Type	rw	rw	rw						
RMAP = 0, PAGE 3											
9A _H	CCU6_MCMOUTL Reset: 00_H Multi-Channel Mode Output Register Low	Bit Field	0	R	MCMP						
		Type	r	rh	rh						
9B _H	CCU6_MCMOUTH Reset: 00_H Multi-Channel Mode Output Register High	Bit Field	0		CURH			EXPH			
		Type	r		rh			rh			
9C _H	CCU6_ISL Reset: 00_H Capture/Compare Interrupt Status Register Low	Bit Field	T12 PM	T12 OM	ICC62 F	ICC62 R	ICC61 F	ICC61 R	ICC60 F	ICC60 R	
		Type	rh	rh	rh	rh	rh	rh	rh	rh	
9D _H	CCU6_ISH Reset: 00_H Capture/Compare Interrupt Status Register High	Bit Field	STR	IDLE	WHE	CHE	TRPS	TRPF	T13 PM	T13 CM	
		Type	rh	rh	rh	rh	rh	rh	rh	rh	
9E _H	CCU6_PISEL0L Reset: 00_H Port Input Select Register 0 Low	Bit Field	ISTRP		ISCC62		ISCC61		ISCC60		
		Type	rw		rw		rw		rw		
9F _H	CCU6_PISEL0H Reset: 00_H Port Input Select Register 0 High	Bit Field	IST12HR		ISPOS2		ISPOS1		ISPOS0		
		Type	rw		rw		rw		rw		
A4 _H	CCU6_PISEL2 Reset: 00_H Port Input Select Register 2	Bit Field	0							IST13HR	
		Type	r							rw	
FA _H	CCU6_T12L Reset: 00_H Timer T12 Counter Register Low	Bit Field	T12CVL								
		Type	rwh								
FB _H	CCU6_T12H Reset: 00_H Timer T12 Counter Register High	Bit Field	T12CVH								
		Type	rwh								
FC _H	CCU6_T13L Reset: 00_H Timer T13 Counter Register Low	Bit Field	T13CVL								
		Type	rwh								
FD _H	CCU6_T13H Reset: 00_H Timer T13 Counter Register High	Bit Field	T13CVH								
		Type	rwh								

Functional Description

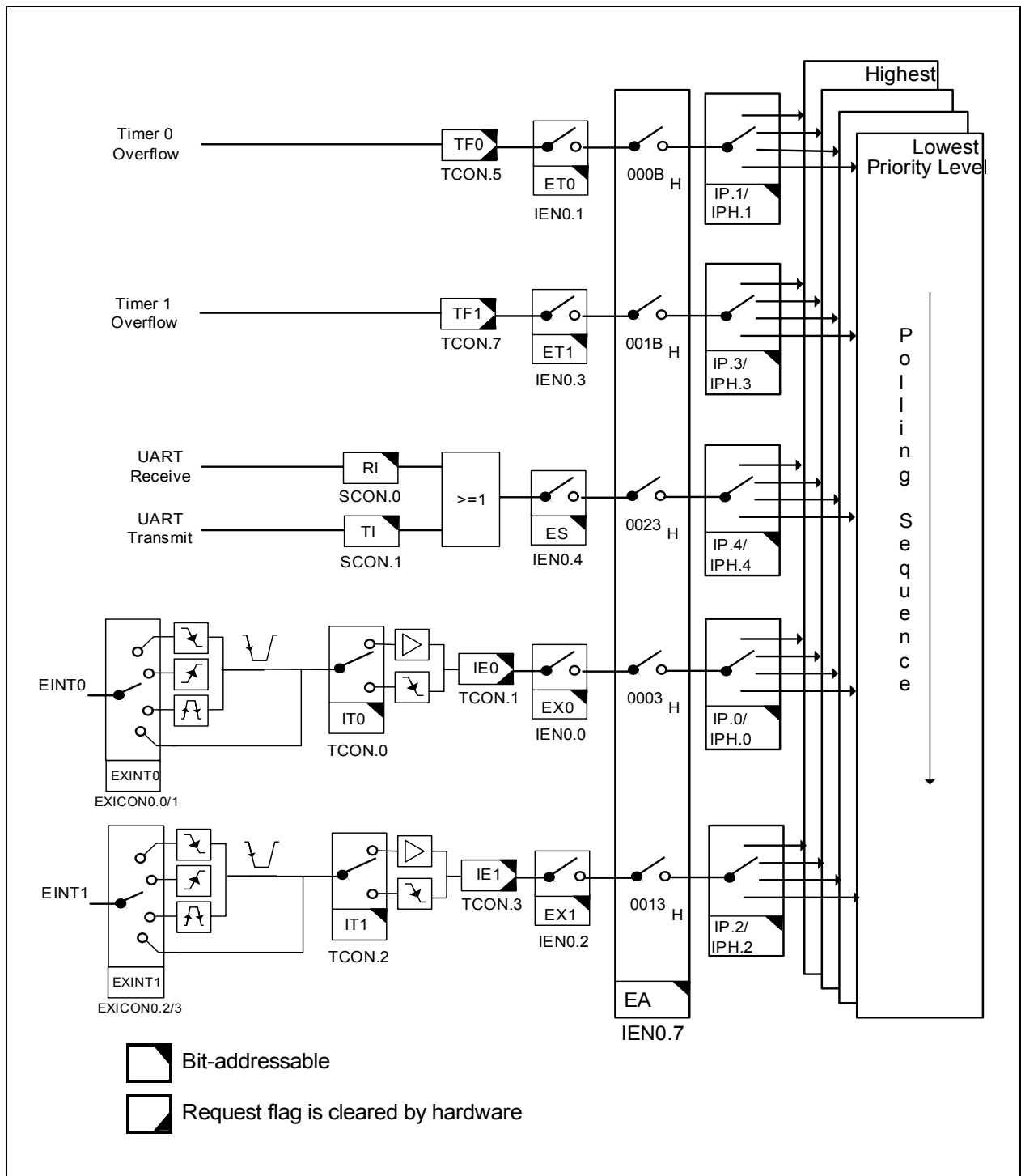


Figure 14 Interrupt Request Sources (Part 1)

3.5 Parallel Ports

The XC886 has 34 port pins organized into five parallel ports, Port 0 (P0) to Port 4 (P4), while the XC888 has 48 port pins organized into six parallel ports, Port 0 (P0) to Port 5 (P5). Each pin has a pair of internal pull-up and pull-down devices that can be individually enabled or disabled. Ports P0, P1, P3, P4 and P5 are bidirectional and can be used as general purpose input/output (GPIO) or to perform alternate input/output functions for the on-chip peripherals. When configured as an output, the open drain mode can be selected. Port P2 is an input-only port, providing general purpose input functions, alternate input functions for the on-chip peripherals, and also analog inputs for the Analog-to-Digital Converter (ADC).

Bidirectional Port Features

- Configurable pin direction
- Configurable pull-up/pull-down devices
- Configurable open drain mode
- Transfer of data through digital inputs and outputs (general purpose I/O)
- Alternate input/output for on-chip peripherals

Input Port Features

- Configurable input driver
- Configurable pull-up/pull-down devices
- Receive of data through digital input (general purpose input)
- Alternate input for on-chip peripherals
- Analog input for ADC module

- Interrupt enabling and corresponding flag

3.13 UART and UART1

The XC886/888 provides two Universal Asynchronous Receiver/Transmitter (UART and UART1) modules for full-duplex asynchronous reception/transmission. Both are also receive-buffered, i.e., they can commence reception of a second byte before a previously received byte has been read from the receive register. However, if the first byte still has not been read by the time reception of the second byte is complete, one of the bytes will be lost.

Features

- Full-duplex asynchronous modes
 - 8-bit or 9-bit data frames, LSB first
 - Fixed or variable baud rate
- Receive buffered
- Multiprocessor communication
- Interrupt generation on the completion of a data transmission or reception

The UART modules can operate in the four modes shown in [Table 29](#).

Table 29 UART Modes

Operating Mode	Baud Rate
Mode 0: 8-bit shift register	$f_{PCLK}/2$
Mode 1: 8-bit shift UART	Variable
Mode 2: 9-bit shift UART	$f_{PCLK}/32$ or $f_{PCLK}/64$ ¹⁾
Mode 3: 9-bit shift UART	Variable

1) For UART1 module, the baud rate is fixed at $f_{PCLK}/64$.

There are several ways to generate the baud rate clock for the serial port, depending on the mode in which it is operating. In mode 0, the baud rate for the transfer is fixed at $f_{PCLK}/2$. In mode 2, the baud rate is generated internally based on the UART input clock and can be configured to either $f_{PCLK}/32$ or $f_{PCLK}/64$. For UART1 module, only $f_{PCLK}/64$ is available. The variable baud rate is set by the underflow rate on the dedicated baud-rate generator. For UART module, the variable baud rate alternatively can be set by the overflow rate on Timer 1.

3.13.1 Baud-Rate Generator

Both UART modules have their own dedicated baud-rate generator, which is based on a programmable 8-bit reload value, and includes divider stages (i.e., prescaler and

Functional Description

needed for the handshaking between the master and slave tasks is provided by the master task through the header portion of the frame.

The header consists of a break and synch pattern followed by an identifier. Among these three fields, only the break pattern cannot be transmitted as a normal 8-bit UART data. The break must contain a dominant value of 13 bits or more to ensure proper synchronization of slave nodes.

In the LIN communication, a slave task is required to be synchronized at the beginning of the protected identifier field of frame. For this purpose, every frame starts with a sequence consisting of a break field followed by a synch byte field. This sequence is unique and provides enough information for any slave task to detect the beginning of a new frame and be synchronized at the start of the identifier field.

Upon entering LIN communication, a connection is established and the transfer speed (baud rate) of the serial communication partner (host) is automatically synchronized in the following steps:

STEP 1: Initialize interface for reception and timer for baud rate measurement

STEP 2: Wait for an incoming LIN frame from host

STEP 3: Synchronize the baud rate to the host

STEP 4: Enter for Master Request Frame or for Slave Response Frame

*Note: Re-synchronization and setup of baud rate are always done for **every** Master Request Header or Slave Response Header LIN frame.*

Functional Description

3.18 Timer 2 and Timer 21

Timer 2 and Timer 21 are 16-bit general purpose timers (THL2) that are fully compatible and have two modes of operation, a 16-bit auto-reload mode and a 16-bit one channel capture mode, see [Table 33](#). As a timer, the timers count with an input clock of PCLK/12 (if prescaler is disabled). As a counter, they count 1-to-0 transitions on pin T2. In the counter mode, the maximum resolution for the count is PCLK/24 (if prescaler is disabled).

Table 33 Timer 2 Modes

Mode	Description
Auto-reload	Up/Down Count Disabled <ul style="list-style-type: none"> Count up only Start counting from 16-bit reload value, overflow at FFFF_H Reload event configurable for trigger by overflow condition only, or by negative/positive edge at input pin T2EX as well Programmable reload value in register RC2 Interrupt is generated with reload event
	Up/Down Count Enabled <ul style="list-style-type: none"> Count up or down, direction determined by level at input pin T2EX No interrupt is generated Count up <ul style="list-style-type: none"> Start counting from 16-bit reload value, overflow at FFFF_H Reload event triggered by overflow condition Programmable reload value in register RC2 Count down <ul style="list-style-type: none"> Start counting from FFFF_H, underflow at value defined in register RC2 Reload event triggered by underflow condition Reload value fixed at FFFF_H
Channel capture	<ul style="list-style-type: none"> Count up only Start counting from 0000_H, overflow at FFFF_H Reload event triggered by overflow condition Reload value fixed at 0000_H Capture event triggered by falling/rising edge at pin T2EX Captured timer value stored in register RC2 Interrupt is generated with reload or capture event

Functional Description

3.20 Controller Area Network (MultiCAN)

The MultiCAN module contains two Full-CAN nodes operating independently or exchanging data and remote frames via a gateway function. Transmission and reception of CAN frames is handled in accordance to CAN specification V2.0 B active. Each CAN node can receive and transmit standard frames with 11-bit identifiers as well as extended frames with 29-bit identifiers.

Both CAN nodes share a common set of message objects, where each message object may be individually allocated to one of the CAN nodes. Besides serving as a storage container for incoming and outgoing frames, message objects may be combined to build gateways between the CAN nodes or to setup a FIFO buffer.

The message objects are organized in double chained lists, where each CAN node has it's own list of message objects. A CAN node stores frames only into message objects that are allocated to the list of the CAN node. It only transmits messages from objects of this list. A powerful, command driven list controller performs all list operations.

The bit timings for the CAN nodes are derived from the peripheral clock (f_{CAN}) and are programmable up to a data rate of 1 Mbaud. A pair of receive and transmit pins connects each CAN node to a bus transceiver.

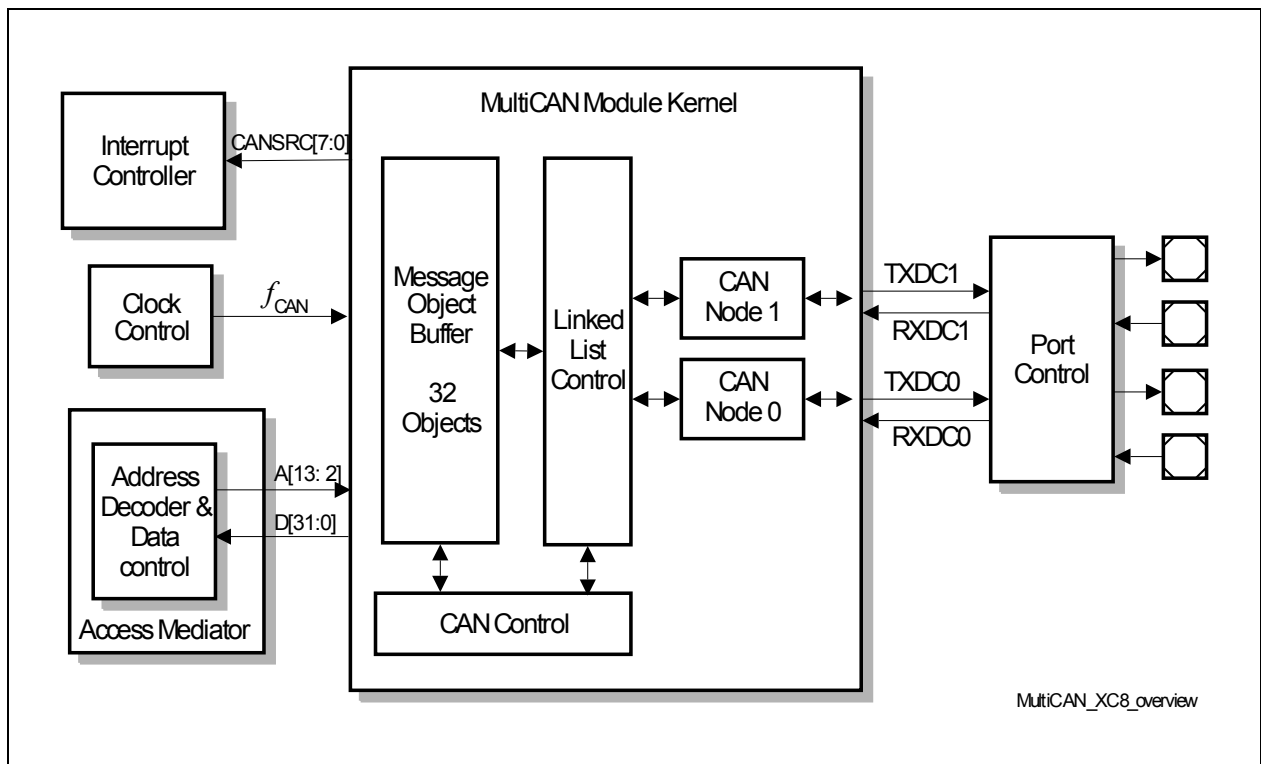


Figure 34 Overview of the MultiCAN

Features

- Compliant to ISO 11898.

Functional Description

GLOBCTR. A prescaling ratio of 32 can be selected when the maximum performance of the ADC is not required.

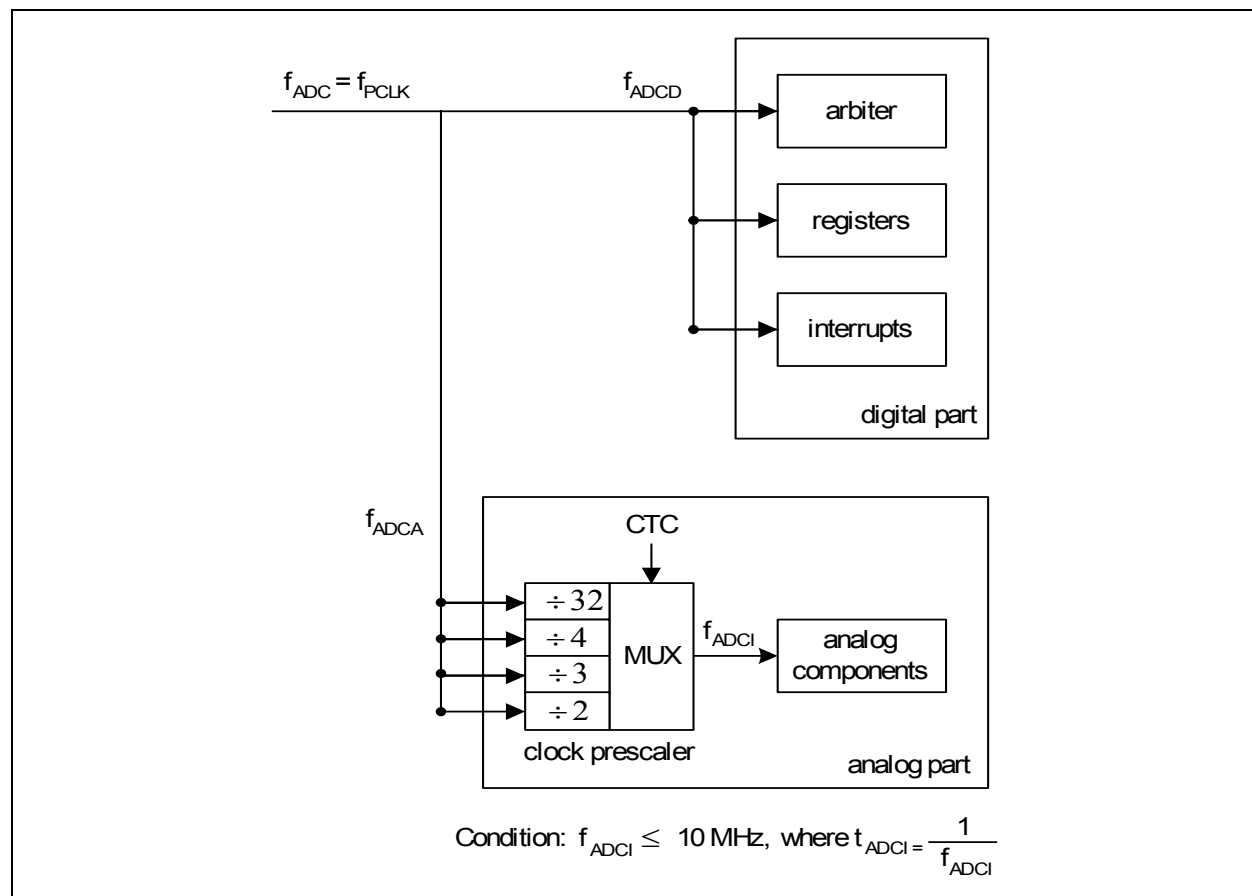


Figure 35 ADC Clocking Scheme

For module clock $f_{ADC} = 24 \text{ MHz}$, the analog clock f_{ADCI} frequency can be selected as shown in [Table 34](#).

Table 34 f_{ADCI} Frequency Selection

Module Clock f_{ADC}	CTC	Prescaling Ratio	Analog Clock f_{ADCI}
24 MHz	00 _B	$\div 2$	12 MHz (N.A)
	01 _B	$\div 3$	8 MHz
	10 _B	$\div 4$	6 MHz
	11 _B (default)	$\div 32$	750 kHz

As f_{ADCI} cannot exceed 10 MHz, bit field CTC should not be set to 00_B when f_{ADC} is 24 MHz. During slow-down mode where f_{ADC} may be reduced to 12 MHz, 6 MHz etc., CTC can be set to 00_B as long as the divided analog clock f_{ADCI} does not exceed 10 MHz.

Functional Description
Table 36 Chip Identification Number (cont'd)

Product Variant	Chip Identification Number		
	AA-Step	AB-Step	AC-Step
XC886-6FFA 3V3	-	095D1562 _H	0B5D1562 _H
XC888-6FFA 3V3	-	095D1563 _H	0B5D1563 _H
XC886CLM-8FFA 5V	-	09900102 _H	0B900102 _H
XC888CLM-8FFA 5V	-	09900103 _H	0B900103 _H
XC886LM-8FFA 5V	-	09900122 _H	0B900122 _H
XC888LM-8FFA 5V	-	09900123 _H	0B900123 _H
XC886CLM-6FFA 5V	-	09951502 _H	0B951502 _H
XC888CLM-6FFA 5V	-	09951503 _H	0B951503 _H
XC886LM-6FFA 5V	-	09951522 _H	0B951522 _H
XC888LM-6FFA 5V	-	09951523 _H	0B951523 _H
XC886CM-8FFA 5V	-	09980102 _H	0B980102 _H
XC888CM-8FFA 5V	-	09980103 _H	0B980103 _H
XC886C-8FFA 5V	-	09980142 _H	0B980142 _H
XC888C-8FFA 5V	-	09980143 _H	0B980143 _H
XC886-8FFA 5V	-	09980162 _H	0B980162 _H
XC888-8FFA 5V	-	09980163 _H	0B980163 _H
XC886CM-6FFA 5V	-	099D1502 _H	0B9D1502 _H
XC888CM-6FFA 5V	-	099D1503 _H	0B9D1503 _H
XC886C-6FFA 5V	-	099D1542 _H	0B9D1542 _H
XC888C-6FFA 5V	-	099D1543 _H	0B9D1543 _H
XC886-6FFA 5V	-	099D1562 _H	0B9D1562 _H
XC888-6FFA 5V	-	099D1563 _H	0B9D1563 _H

ROM Devices

XC886CLM-8RFA 3V3	22400502 _H	-	-
XC888CLM-8RFA 3V3	22400503 _H	-	-
XC886LM-8RFA 3V3	22400522 _H	-	-
XC888LM-8RFA 3V3	22400523 _H	-	-
XC886CLM-6RFA 3V3	22411502 _H	-	-
XC888CLM-6RFA 3V3	22411503 _H	-	-

Electrical Parameters
Table 38 Input/Output Characteristics (Operating Conditions apply) (cont'd)

Parameter	Symbol		Limit Values		Unit	Test Conditions
			min.	max.		
Maximum current out of V_{SS}	I_{MVSS}	SR	–	120	mA	³⁾
$V_{DDP} = 3.3 \text{ V Range}$						
Output low voltage	V_{OL}	CC	–	1.0	V	$I_{OL} = 8 \text{ mA}$
			–	0.4	V	$I_{OL} = 2.5 \text{ mA}$
Output high voltage	V_{OH}	CC	$V_{DDP} - 1.0$	–	V	$I_{OH} = -8 \text{ mA}$
			$V_{DDP} - 0.4$	–	V	$I_{OH} = -2.5 \text{ mA}$
Input low voltage on port pins (all except P0.0 & P0.1)	V_{ILP}	SR	–	$0.3 \times V_{DDP}$	V	CMOS Mode
Input low voltage on P0.0 & P0.1	V_{ILP0}	SR	-0.2	$0.3 \times V_{DDP}$	V	CMOS Mode
Input low voltage on RESET pin	V_{ILR}	SR	–	$0.3 \times V_{DDP}$	V	CMOS Mode
Input low voltage on TMS pin	V_{ILT}	SR	–	$0.3 \times V_{DDP}$	V	CMOS Mode
Input high voltage on port pins (all except P0.0 & P0.1)	V_{IHP}	SR	$0.7 \times V_{DDP}$	–	V	CMOS Mode
Input high voltage on P0.0 & P0.1	V_{IHP0}	SR	$0.7 \times V_{DDP}$	V_{DDP}	V	CMOS Mode
Input high voltage on RESET pin	V_{IHR}	SR	$0.7 \times V_{DDP}$	–	V	CMOS Mode
Input high voltage on TMS pin	V_{IHT}	SR	$0.75 \times V_{DDP}$	–	V	CMOS Mode
Input Hysteresis	HYS	CC	$0.03 \times V_{DDP}$	–	V	CMOS Mode ¹⁾
Input Hysteresis on XTAL1	$HYSX$	CC	$0.07 \times V_{DDC}$	–	V	¹⁾
Input low voltage at XTAL1	V_{ILX}	SR	$V_{SS} - 0.5$	$0.3 \times V_{DDC}$	V	

4.2.3.1 ADC Conversion Timing

Conversion time, $t_C = t_{ADC} \times (1 + r \times (3 + n + \text{STC}))$, where

$r = \text{CTC} + 2$ for $\text{CTC} = 00_B, 01_B$ or 10_B ,

$r = 32$ for $\text{CTC} = 11_B$,

CTC = Conversion Time Control (GLOBCTR.CTC),

STC = Sample Time Control (INPCR0.STC),

$n = 8$ or 10 (for 8-bit and 10-bit conversion respectively),

$t_{ADC} = 1 / f_{ADC}$

Electrical Parameters

Table 44 Power Down Current (Operating Conditions apply; $V_{DDP} = 3.3V$ range)

Parameter	Symbol	Limit Values		Unit	Test Condition
		typ. ¹⁾	max. ²⁾		
$V_{DDP} = 3.3V$ Range					
Power-Down Mode	I_{PDP}	1	10	μA	$T_A = + 25\text{ }^{\circ}C^{3)4)}$
		-	30	μA	$T_A = + 85\text{ }^{\circ}C^{4)5)}$

1) The typical I_{PDP} values are measured at $V_{DDP} = 3.3\text{ V}$.

2) The maximum I_{PDP} values are measured at $V_{DDP} = 3.6\text{ V}$.

3) I_{PDP} has a maximum value of $200\text{ }\mu A$ at $T_A = + 125\text{ }^{\circ}C$.

4) I_{PDP} is measured with: $\overline{RESET} = V_{DDP}$, $V_{AGND} = V_{SS}$, $RXD/INT0 = V_{DDP}$; rest of the ports are programmed to be input with either internal pull devices enabled or driven externally to ensure no floating inputs.

5) Not subjected to production test, verified by design/characterization.

Package and Quality Declaration
5.3 Quality Declaration

Table 2 shows the characteristics of the quality parameters in the XC886/888.

Table 2 Quality Parameters

Parameter	Symbol	Limit Values		Unit	Notes
		Min.	Max.		
ESD susceptibility according to Human Body Model (HBM)	V_{HBM}	-	2000	V	Conforming to EIA/JESD22-A114-B ¹⁾
ESD susceptibility according to Charged Device Model (CDM) pins	V_{CDM}	-	500	V	Conforming to JESD22-C101-C ¹⁾

1) Not all parameters are 100% tested, but are verified by design/characterization and test correlation.

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